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## APPLICANTS

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## \*\* CONTINUING DATA \*\*

This application is a DIV of 10/409,804 04/09/2003 NOW US PATENT NO. 7,102,217

## \*\* FOREIGN APPLICATIONS \*\*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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Foreign Priority claimed 35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY ID	SHEETS DRAWING 4	TOTAL CLAIMS 1420	INDEPENDENT CLAIMS 12
Verified and Acknowledged	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no Met after Allowance				
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## TITLE

Interposer substrates with multi-segment interconnect slots, semiconductor die packages including same,  
semiconductor dice for use therewith and methods of fabrication OF INTERPOSER SUBSTRATES WITH MULTISEGMENT INTERCONNECT SLOTS

FILING FEE  RECEIVED 770	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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